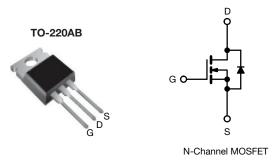
SiHP054N65E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	700			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.051		
Q _g max. (nC)	108			
Q _{gs} (nC)	25			
Q _{gd} (nC)	26			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP054N65E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	650	V	
Gate-source voltage			V _{GS}	± 30	V	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	I _D	47	А	
	VGS AL TU V	T _C = 100 °C		30		
Pulsed drain current ^a			I _{DM}	127		
Linear derating factor				2.5	W/°C	
Single pulse avalanche energy ^b			E _{AS}	285	mJ	
Maximum power dissipation			PD	312	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$		dv/dt	100			
Reverse diode dv/dt ^d			25	V/ns		
Soldering recommendations (peak temperature	e) ^c	For 10 s		260	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4.5 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D$, di/dt = 70 A/µs, starting T_J = 25 °C



COMPLIANT

HALOGEN

FREE



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PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R _{thJA}	-		62 0.4					
Maximum junction-to-case (drain)	R _{thJC}	-				°C/W			
SPECIFICATIONS (T _J = 25 °C,	unless otherw	ise noted)							
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNI	
Static					1			I	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 µA	650	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.61	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μA	3.0	-	5.0	V	
		,	$V_{GS} = \pm 20^{\circ}$	V	-	-	± 100	nA	
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V		-	-	± 1	μA	
			= 650 V, V _{GS}		-	-	1		
Zero gate voltage drain current	I _{DSS}	V _{DS} = 520 V	$V_{DS} = 520 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	-	10	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$ $I_D = 20 \text{ A}$		-	0.051	0.058	Ω		
Forward transconductance	9 _{fs}		= 10 V, I _D =	20 A	-	19	-	S	
Dynamic							1		
Input capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 100 V,		-	3769	-	-		
Output capacitance	C _{oss}			-	147	-			
Reverse transfer capacitance	C _{rss}	_	f = 100 KHz		-	2	-	1	
Effective output capacitance, energy related	C _{o(er)}	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		-	115	-	pF		
Effective output capacitance, time related	C _{o(tr)}			-	772	-			
Total gate charge	Qg				-	72	108		
Gate-source charge	Q _{gs}	V _{GS} = 20 V I _D = 19 A, V _{DS} = 520 V		-	25	-	nC		
Gate-drain charge	Q _{gd}	_			-	26	-	1	
Turn-on delay time	t _{d(on)}	$V_{DD} = 520 \text{ V}, \text{ I}_{D} = 20 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	35	70			
Rise time	tr			-	51	102	- ns		
Turn-off delay time	t _{d(off)}			-	62	124			
Fall time	t _f			-	32	64			
Gate input resistance	R _g	f = 1 MHz, open drain		0.3	0.6	1.2	Ω		
Drain-Source Body Diode Characteris		•			•	•			
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	47			
Pulsed diode forward current	I _{SM}			-	-	127	A		
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 20 A,	V _{GS} = 0 V	-	-	1.2	V	
Reverse recovery time	t _{rr}	-			-	513	1026	ns	
Reverse recovery charge	Q _{rr}	$T_J = 2$	$5 ^{\circ}\text{C}, I_{\text{F}} = I_{\text{S}}$	= 20 A,	-	7.1	14.2	μC	
Reverse recovery current	I _{RRM}	di/dt = 70 A/µs, V _R = 25 V		-	23	-	A		



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

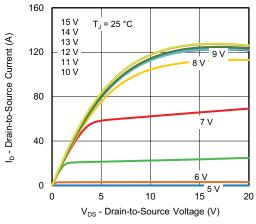


Fig. 1 - Typical Output Characteristics

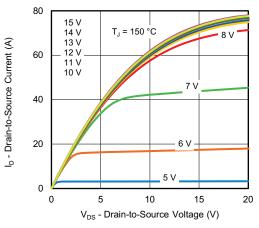


Fig. 2 - Typical Output Characteristics

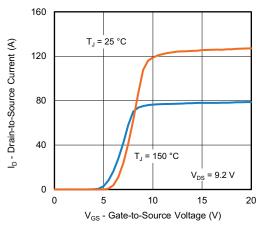


Fig. 3 - Typical Transfer Characteristics

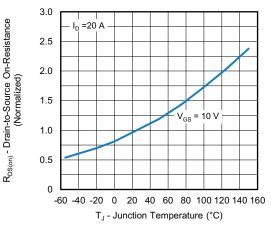


Fig. 4 - Normalized On-Resistance vs. Temperature

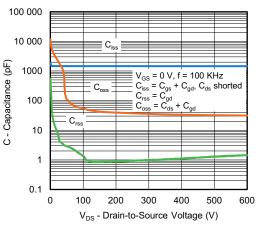
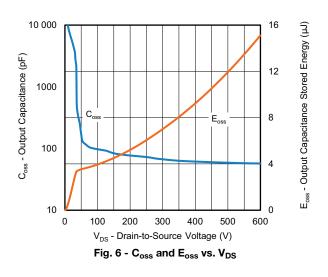


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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SiHP054N65E

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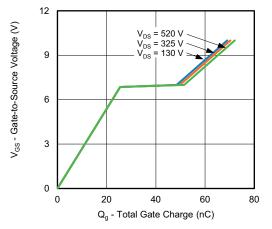


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

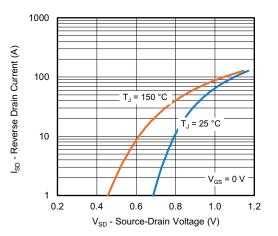


Fig. 8 - Typical Source-Drain Diode Forward Voltage

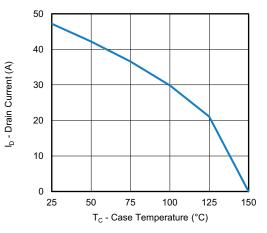


Fig. 9 - Maximum Drain Current vs. Case Temperature

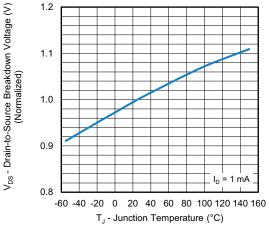
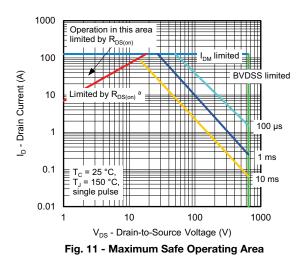


Fig. 10 - Temperature vs. Drain-to-Source Voltage



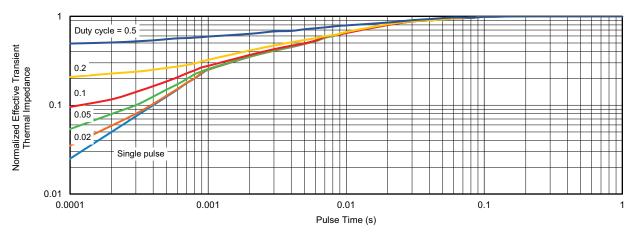
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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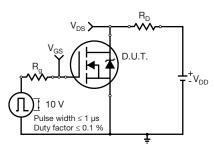


Fig. 13 - Switching Time Test Circuit

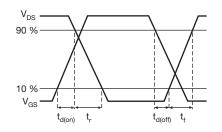


Fig. 14 - Switching Time Waveforms

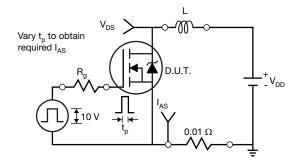
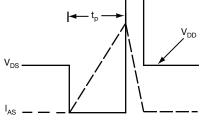


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

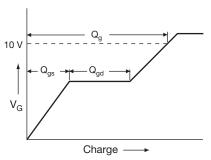
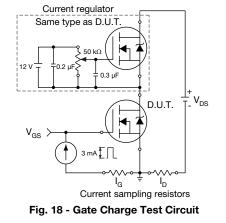
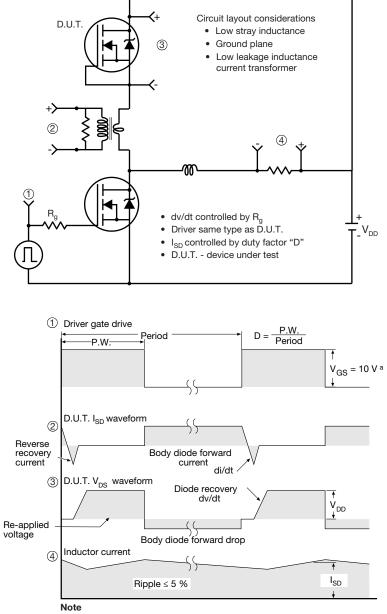


Fig. 17 - Basic Gate Charge Waveform





Peak Diode Recovery dv/dt Test Circuit



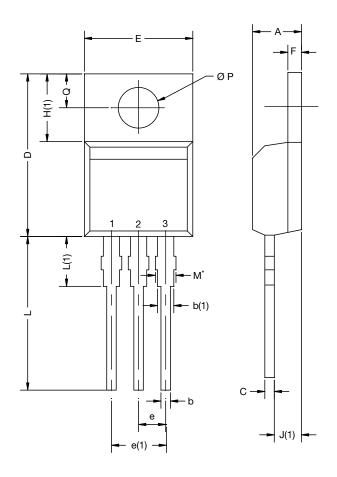
a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INCI	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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